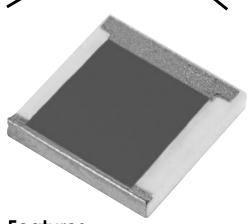


Model RFP-375375-6X50-2

Chip Terminations 300 Watts, 50 Ω

RF Power



Features

- DC 1.0 GHz
- 300 Watts
- BeO Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

General Specifications

Resistive Element: Thick film

Substrate: Beryllium oxide ceramic

Terminals: Thick film silver

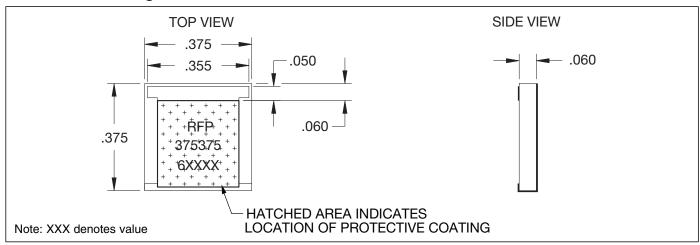
Electrical Specifications

Resistance Value:50 ohms, $\pm 2\%$ Frequency Range:DC - 1.0 GHzPower:300 WattsV.S.W.R.:1.25:1

Notes: Tolerance is ±.010, unless otherwise specified. Operating temperature is -55°C to +150°C (see chart). Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions are in inches.

Specifications subject to change without notice.

Outline Drawing



VER. 12/5/01

Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121

Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

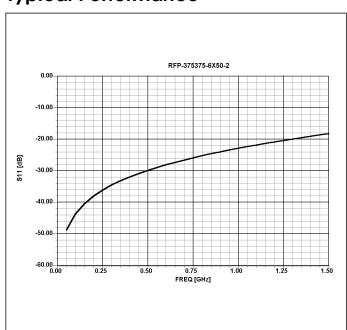


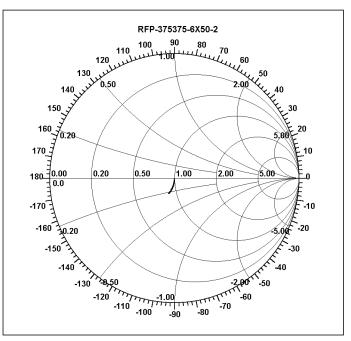
Model RFP-375375-6X50-2



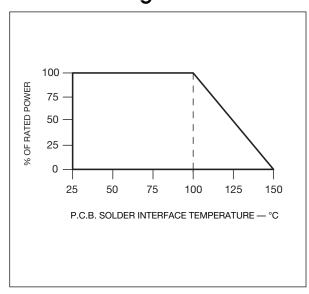


Typical Performance

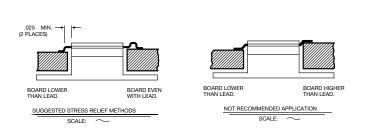




Power Derating



Suggested Mounting Procedures



- Make sure that the devices are mounted on flat surfaces (.001" under the device) to optimize the heat transfer.
- 2. Position device on mounting surface and solder in place using an indalloy type or a 60/40 type solder.
- 3. Solder leads in place using a 60/40 type solder with a controlled temperature iron (700°F).

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